

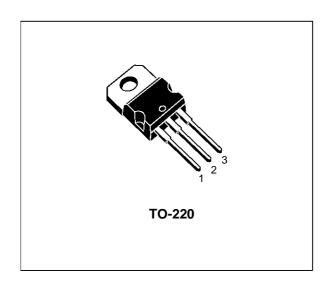
SILICON NPN SWITCHING TRANSISTOR

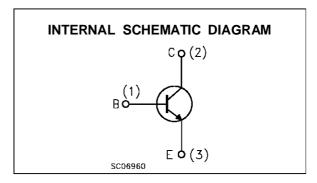
- LOW SATURATION VOLTAGE
- FAST TURN-ON AND TURN-OFF
- BASE DRIVE SPECIFIED FOR DIFFERENT VALUES OF I_C
- WIDE SURGE AREA

DESCRIPTION

High speed transistor suited for low voltage applications.

High frequency and efficiency converters switching regulators motor control.





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-base Voltage (I _E = 0)	180	V
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	90	V
V_{EBO}	Emitter-Base Voltage (I _C = 0)	7	V
Ic	Emitter Current	14	Α
I _{CM}	Collector Peak Current (tp <10ms)	25	Α
lΒ	Base Current	4	Α
I _{BM}	Base Peak Current (t _p <10ms)	6	Α
P_{tot}	Total Dissipation at Tc < 25 °C	85	W
P _{tot}	Total Dissipation at T _c < 60 °C	65	W
T _{stg}	Storage Temperature	-65 to +175	°C
Tj	Max. Operating Junction Temperature	175	°C

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THERMAL DATA

R _{thj-case} Thermal Resistance Junction-case	Max	1.76	°C/W
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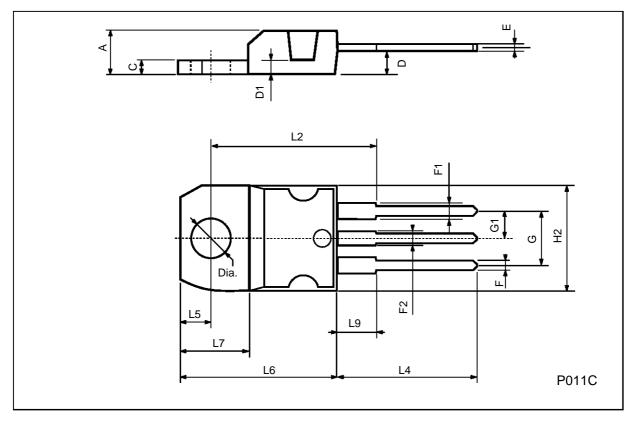
ELECTRICAL CHARACTERISTICS ($T_{case} = 25$ °C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{CER}	Collector Cut-off Current ($R_{BE} = 50\Omega$)	$V_{CE} = 180V T_c = 125^{\circ}C$			3	mA
I _{CEX}	Collector Cut-off Current	$V_{CE} = 180V V_{BE} = -1.5V T_{c} = 125^{\circ}C$			1	mA
I _{EBO}	Emitter Cut-off Current (I _C = 0)	V _{EB} = 5 V			1	mA
V _{CEO(sus)} *	Collector-Emitter Sustaining Voltage	I _C = 0.2mA L = 25mH	90			V
V _{EBO}	Emitter-Base Voltage (I _C = 0)	I _E = 50mA	7		30	V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	$I_{C} = 6A$ $I_{B} = 0.6A$ $I_{C} = 12A$ $I_{B} = 1.2A$			0.6 1.5	V V
V _{BE(sat)*}	Base-Emitter Saturation Voltage	I _C =12A I _B = 1.2A			2	V
t _{on} t _s	RESISTIVE LOAD Turn-on Time Storage Time Fall Time	$V_{CC} = 50V$ $I_{C} = 12A$ $V_{BE} = -6V$ $I_{B1} = 1.2A$ $R_{BB} = 2.5\Omega$		0.4 0.45 0.12	0.6 1 0.25	ms µs µs
t _s t _f t _s t _f	Storage time Fall Time Storage Time Fall Time	$\begin{array}{cccccccccccccccccccccccccccccccccccc$		0.5 0.04	2 0.15	μs μs μs

^{*} Pulsed: Pulse duration = 300μs, duty cycle = 1.5 %

TO-220 MECHANICAL DATA

DIM.		mm			inch	
DIWI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α	4.40		4.60	0.173		0.181
С	1.23		1.32	0.048		0.051
D	2.40		2.72	0.094		0.107
D1		1.27			0.050	
Е	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.067
F2	1.14		1.70	0.044		0.067
G	4.95		5.15	0.194		0.203
G1	2.4		2.7	0.094		0.106
H2	10.0		10.40	0.393		0.409
L2		16.4			0.645	
L4	13.0		14.0	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.2		6.6	0.244		0.260
L9	3.5		3.93	0.137		0.154
DIA.	3.75		3.85	0.147		0.151



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